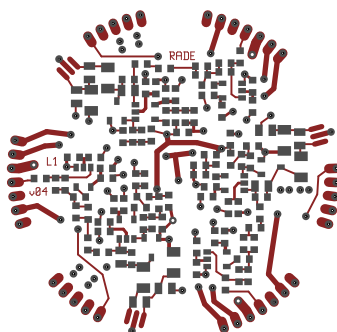
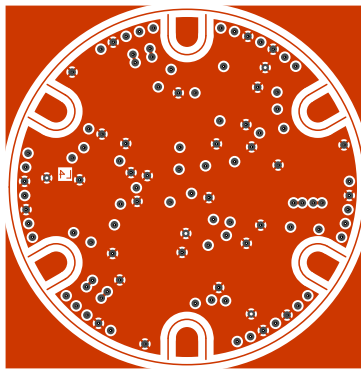


2. component
3. solder
4. Board
5. GND
6. power
7. componentmask
8. soldermask
9. plated-drill
10. topsilk
11. bottomsilk
12. toppaste
13. topassembly
14. bottomassembly
15. fab

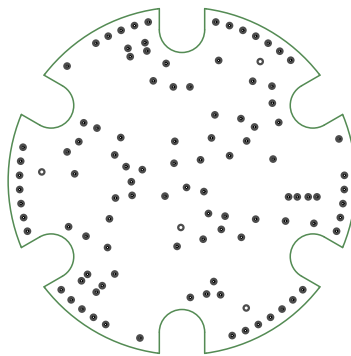
Layer component



Layer solder

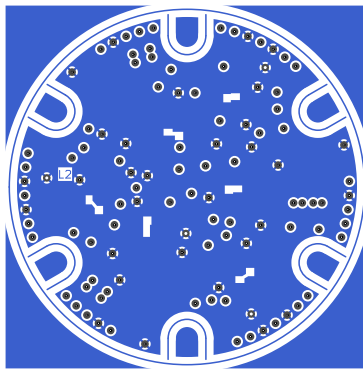


Layer Board

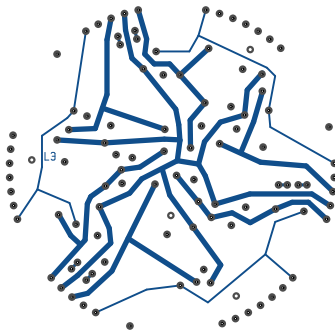


RADE v04 \$Revision: 1.22 \$

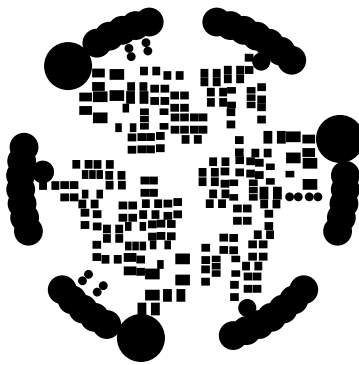
Layer GND



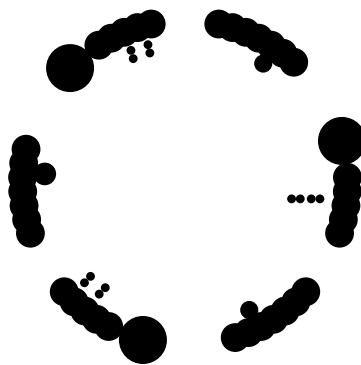
Layer power



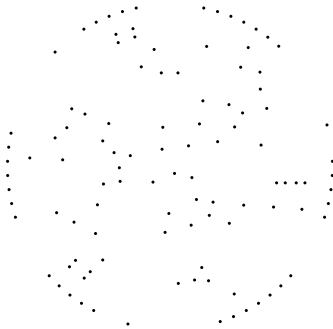
Layer componentmask



Layer soldermask



Layer plated-drill

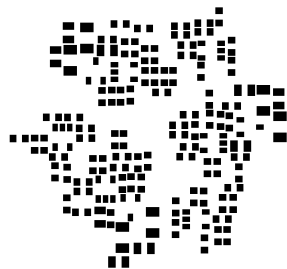


Layer topsilk

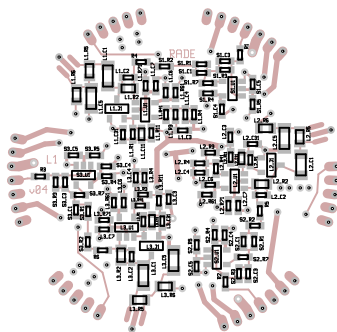


Layer bottomsilk

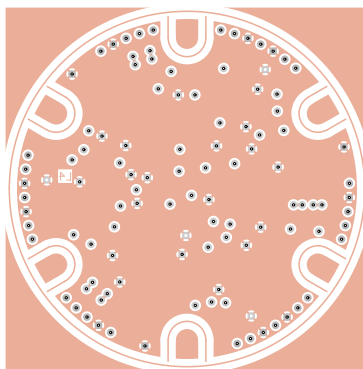
Layer toppaste



Layer topassembly



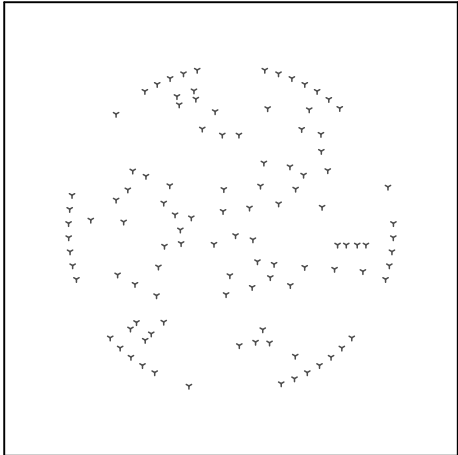
Layer bottomassembly



There are 1 different drill sizes used in this layout, 107 holes total

Symbol	Diam. (Inch)	Count	Plated?
Y	<u>0.016</u>	<u>107</u>	<u>YES</u>

Title: RADE - Fabrication Drawing
Author: Stephan Boettcher
Date: Tue Dec 12 12:58:55 2006 UTC
Maximum Dimensions: 2362 mils wide, 2362 mils high



Board outline is the centerline of this 10 mil rectangle - 0,0 to 2362,2362 mils